

R-1

Features

- ROHS compliant
- Glass passivated chip
- High forward surge capability
- Meet MSL level 1, per J-STD-020
LF maximum peak of 250 °C
- Solder dip 260 °C / 40S
- Component in accordance to ROHS 2002/95/EC and WEEE 2002/96/WC
- UL recognition, file number E342874


Primary characteristics

$I_{F(AV)}$	1A
V_{RRM}	50V to 1000V
I_{FSM}	30A
I_{RM}	5 μ A
V_{FM} at $I_F=1A$	1.1V
T_J max.	150 °C

Applications

Ideal for ac-to-dc bridge full wave rectification such as SMPS, home appliances, office equipment, industrial automation applications

Mechanical data

- Case: R-1
- Epoxy meets UL 94 V-0 flammability rating
- Terminals: Tin plated leads.
- Polarity: As marked.
- Mounting Torque: 10cm·kg(8.8 inches·lbs)max.
- Recommended Torque: 5.7 cm·kg(5 inches·lbs)

Maximum rating (Ta=25°C unless otherwise noted)

Parameter	Sym	R-1							Unit
		1G1	1G2	1G3	1G4	1G5	1G6	1G7	
Max. repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Max. RMS reverse voltage	V_{RMS}	35	70	140	280	420	560	700	V
Max. DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Max. average forward current	$I_{F(AV)}$	1							A
Non-repetitive peak forward surge current 8.3ms single half-sine-wave	I_{FSM}	30							A
Max. instantaneous forward voltage drop per diode	V_{FM}	1.1(1A)							V
Max. instantaneous reverse current at rated DC blocking voltage	I_{RM}	5							μ A
		100							μ A
Operating junction temperature	T_J	-55 ~ +150							°C
Storage temperature	T_{STG}	-55 ~ +150							°C
Typical junction capacitance (Note 1)	C_J	15							pF

Notes:

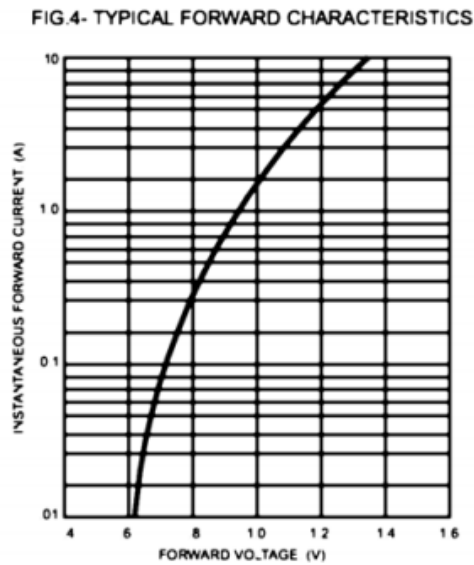
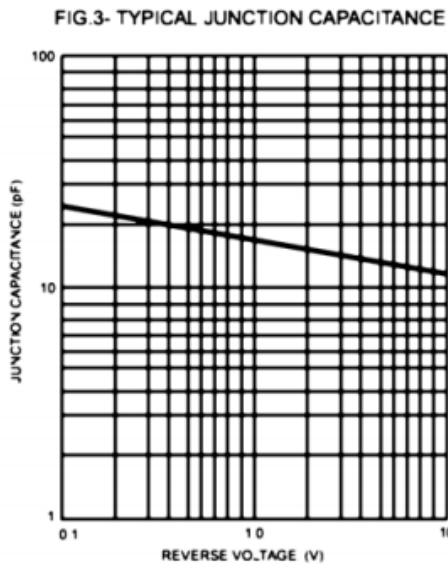
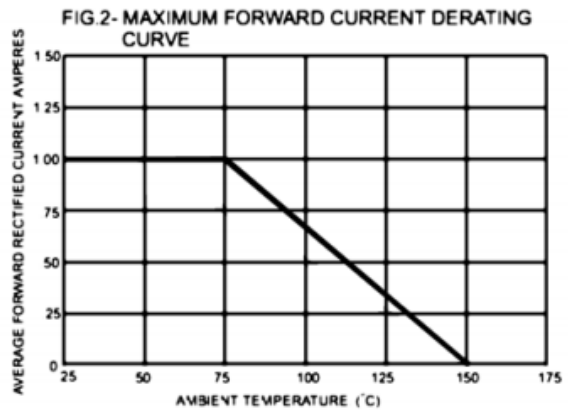
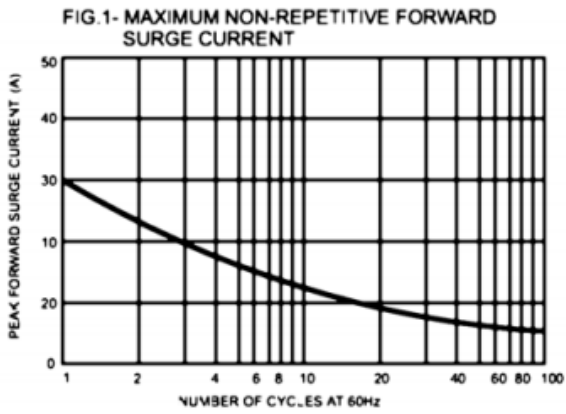
1. Measured at 1 MHz and Applied Reverse Voltage of 4.0 V D.C



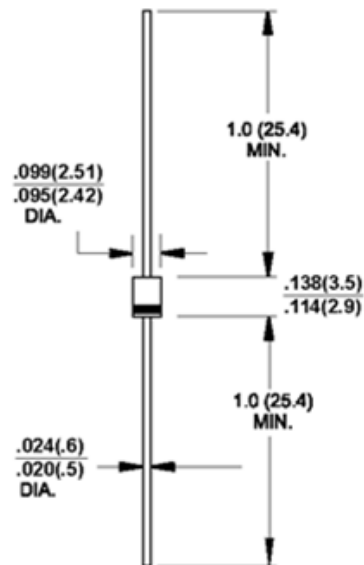
Ordering information (Example)

PREFERRED	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
1G7				

Typical characteristics



Package outline dimensions



Dimensions in inches and (millimeters)

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